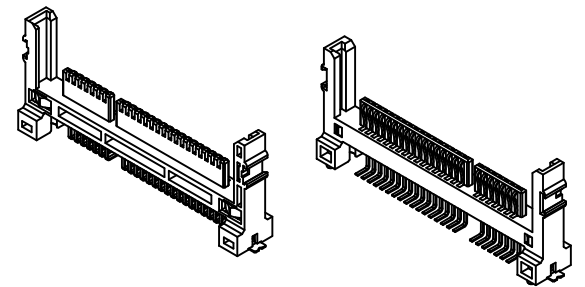
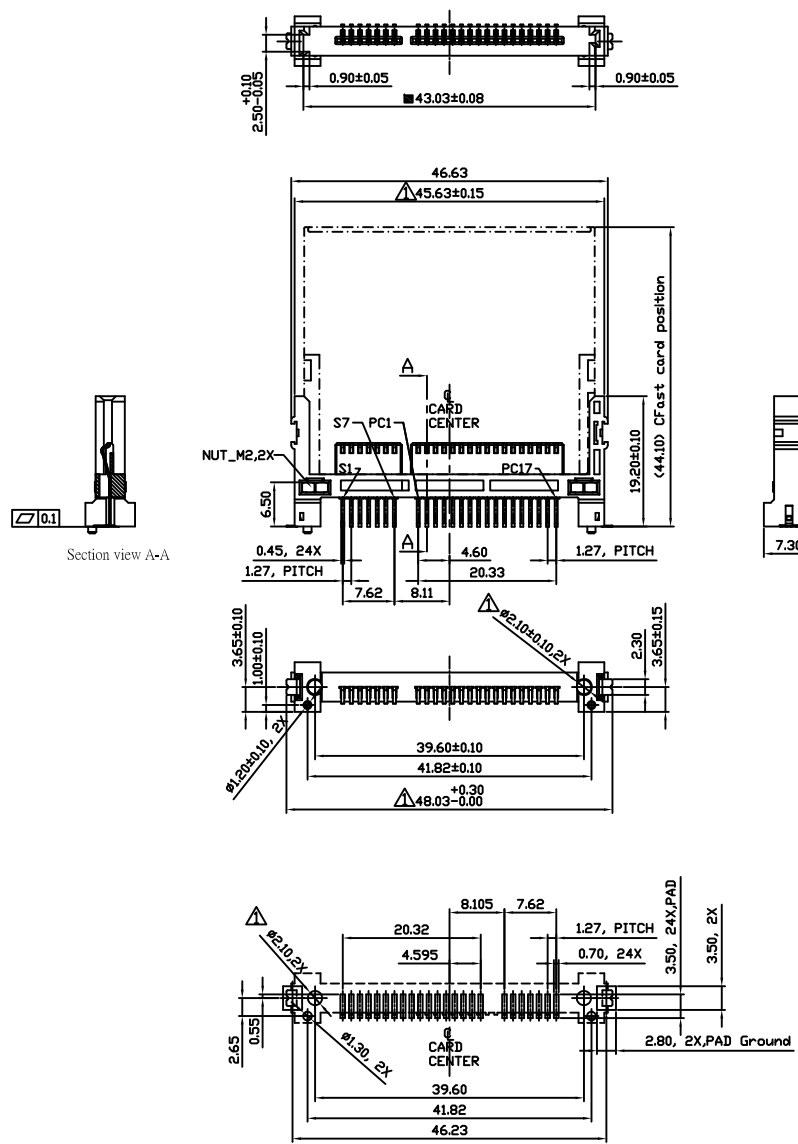


更改 REV	核准 MODIFICATION
A	ECXXXX



- NOTES: 1. MATERIAL:
 1-1 Housing : Engineering plastic , LCP with G.F reinforced , black per UL 94V-0 rate.
 1-2 Terminal : Phosphor Bronze , per JIS 5210 , 0.2t
 2. PLATING:
 2-1 CONTACTS: 0.762 μm (30 μ") gold plating in contact area.and 2.54 μm (100 μ") min. matte Tin in soldering zone, over entire contact underplated with 1.27 μm (50 μ") min. Nickel over all.
 2-2 Solder zone: 2.54 μm (100 μ") matte Tin, 1.27 μm (50 μ") min. Nickel underplating over all.
 3. RoHS compliant products.
 4. OPERATING TEMPERATURE: -40°C~+85°C

PCB T=1.0±0.1
 TOLERANCE: ±0.1
 RECOMMENDED P.C. BOARD LAYOUT

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X*± 5 °	名 稱(TITLE) Cfast host_Stand Off	
.X± 0.30	.X*± 2 °		
.XX± 0.20	.XX*± 1 °		
單 位(UNIT)	料 號(PART NO.)	圖 號(DWG NO.)	
mm	7CFST-CA-0033	7CFST-CA-0033-A	
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	比 例 SCALE 1:1 圖 號 SHEET 1 / 1 製 改 REV A

